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Optical Film Thickness Gauge

SM200

Feature

- Wide film thickness range $(1nm \sim 250um)$
- Wide wavelength range (200-1700nm)
- Non-contact, non-destructive testing system;
- Ultra-long life light source, higher luminous efficiency
- Compact and affordable without compromising high precision
- High-resolution, highsensitivity spectrometer, the measurement results are more accurate and reliable
- The software interface is intuitive, and the operation is convenient and time-saving
- Historical data storage to help users better grasp the results
- Optical constant analysis (n: Refractive index, k: Extinction coefficient) with Non-linear Least-Squares Method
- Analytical algorisms are Peak-Valley Method, Fast Fourier Transformation (FFT) Method, Non-linear Least-Squares Method and Optimization Method

Description

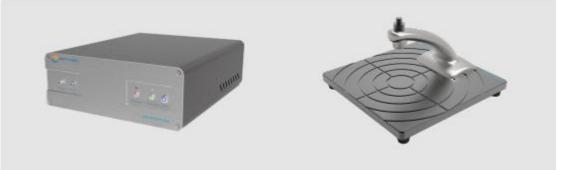
SM200 is an automatic thin film thickness mapper developed by utilizing the principle of thin film reflected light interference. It uses the light with the widest wavelength range of 200- 1700nm to vertically incident on the surface of the film. As long as the film has a certain degree of transmission, the SM200 can calculate the thickness of the film according to the reflected interference spectrum, as well as other optical constants such as reflectivity. refractive index and extinction coefficient, etc. the thickness of the maximum mapping range can reach 1nm ~ 250um.

The SM200 automatic optical film thickness mapper is constructed by the surveying and mapping host, the surveying and mapping platform, the Y-type optical fiber and the host computer software. The leading generation of automated optical film thickness gauges.

Application

Virtually all smooth, translucent or low absorption coefficient films can be mapped, which includes almost all dielectric and semiconductor materials, including silicon dioxide,nitriding layer,diamond-like carbon,polycrystalline silicon,polycrystalline silicon,polycryst

- Semiconductor coating: photoresist, oxide, desalination layer, silicon-on-insulator, wafer back grinding;
- Liquid crystal display: gap thickness, polyimide,ITO transparent conductive film;
- Optical coating: hard coating, anti-reflection layer;
- Microelectronic system: photoresist, silicon film, printed circuit board;
- Biomedical: medical equipment, Parylene

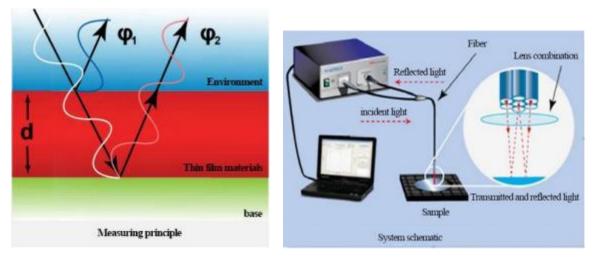


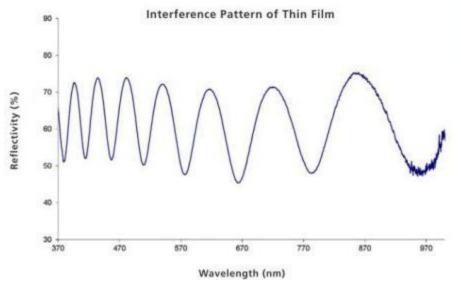


1. Work Principle

When the incident light penetrates the interface of different materials, part of the light will be reflected. Due to the fluctuation of light, the reflected light from multiple interfaces interferes with each other, so that the multi-wavelength spectrum of the reflected light oscillates. From the oscillation frequency of the spectrum, we can judge the distance of different interfaces and then obtain the thickness of the material (more oscillations represent a larger thickness), and other material properties such as refractive index and roughness can also be measured at the same time, as shown in the left figure below.

Optosky fully absorbed the pain points of the industry, dug deep into the needs of customers, and devoted itself to building the leading automatic film thickness measuring instrument in China - SM200, which emits light from the host light source and irradiates the surface of the sample to be measured through the Y-type optical fiber. The Y-type fiber is composed of 7 thin fibers to form a plum blossom, the outer 6 fibers emit light, and the middle fiber guides the reflected interference light back to the spectrometer inside the host for measurement and calculation. The principle of SM200 system is shown in the figure below right.







2. Parameters

	SM2	00-HUV			
	SM200-	LUV			
		SM200			
	SM200-		-NIR		
Inm	1 1 10nm 100r	im 1μm	1 10μm 100	I I Dμm 1mm	
Model	SM200-LUV	SM200-HUV	SM200	SM200-NIR	
General specificat	ions				
Spectral range	200nm- 1000nm	200nm- 1000nm	400nm- 1000nm	900nm- 1700nm	
Light source	Deuteriu	Deuterium halogen Lamp		Tungsten halogen lamp	
Measurement spe	cifications		I.		
Thickness range ¹	1nm- 10um	1nm~30um	20nm-60um	100nm-250um	
Accuracy ²		±2nm 或 0.2%		±3nm 或 0.4%	
Incidence angle	90°				
Film thickness laye	1~3				
Sample material	Transparent or translucent film				
Measurement mode	Single- point/ multi- point/ automated measurements				
Spot size ³	2mm				
Sample size	Diameters from 1 mm to 300 mm or larger				
Basic requirement	s				
Operating system	Windows10/11				
Indicator light	-	Deuterium lamp indication, halogen lamp indication Halogen lamp indication		lamp indication	
Button	Power buttons, deuterium lamps, halogen lamps Power button, halogen power				
External interface		Power outlet, USB 2.0, RJ45			
Scanning platform		Rotate + X axis movement			
Movable stroke		150mm*360°			
Material	Aluminum alloy				
Power supply		100~240VAC , 50~60Hz			
Packing list	Mainframe, m	Mainframe, measuring platform, power cord, communication cable, optical probe, Y-fiber			